

MSG330C4

SiGe HBT type

For low-noise RF amplifier

■ Features

- Compatible between high breakdown voltage and high cutoff frequency
- Low-noise, high-gain amplification
- Suitable for high-density mounting and downsizing of the equipment for Ultraminiature package 0.8 mm × 1.2 mm (height 0.52 mm)

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

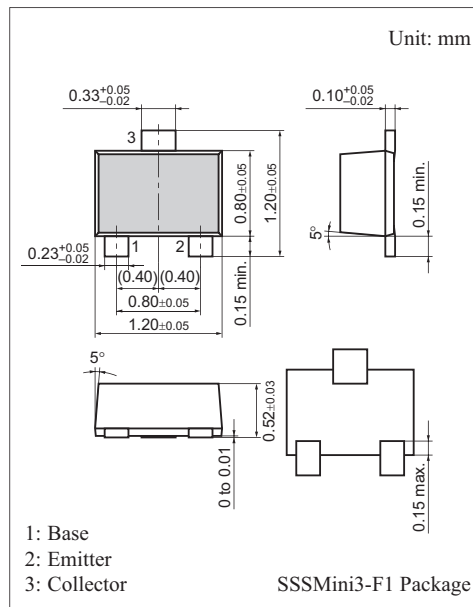
Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	9	V
Collector-emitter voltage (Base open)	V_{CEO}	6	V
Emitter-base voltage (Collector open)	V_{EBO}	1	V
Collector current	I_C	100	mA
Collector power dissipation *	P_C	100	mW
Junction temperature	T_j	125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +125	$^\circ\text{C}$

Note) Copper plate at the collector is 5.0 mm² on substrate at 10 mm × 12 mm × 0.8 mm.

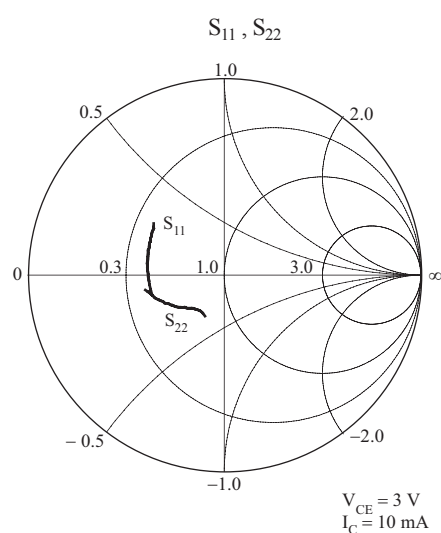
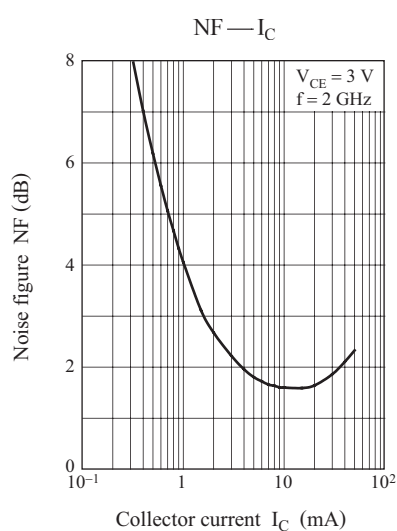
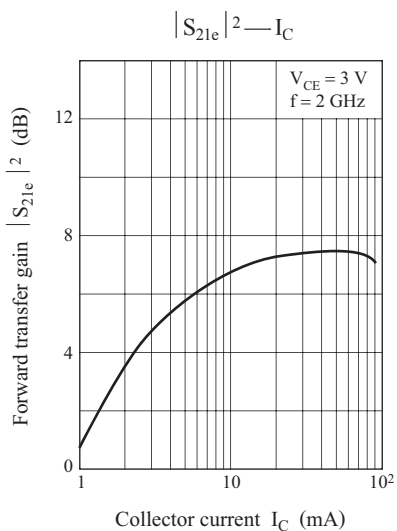
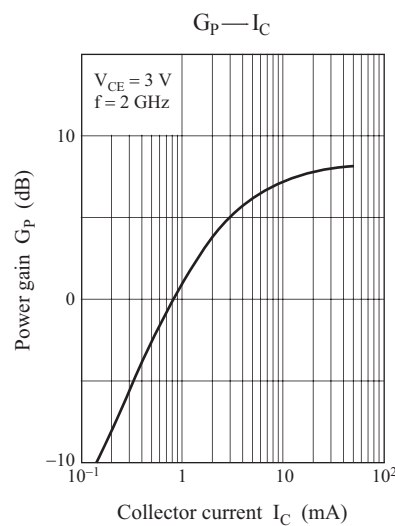
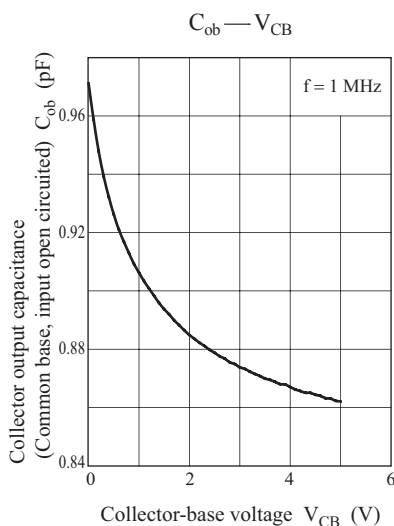
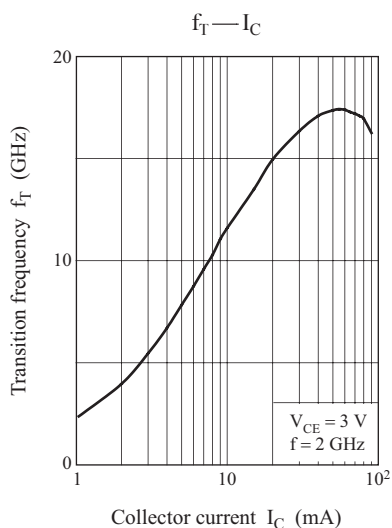
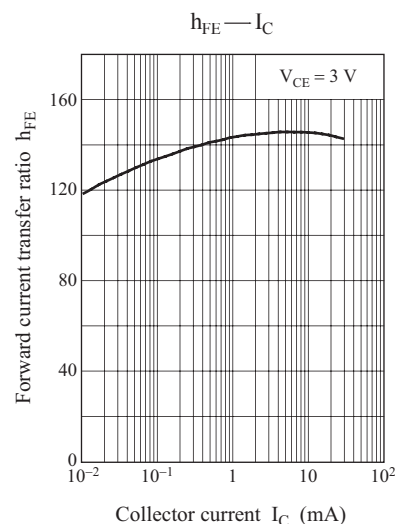
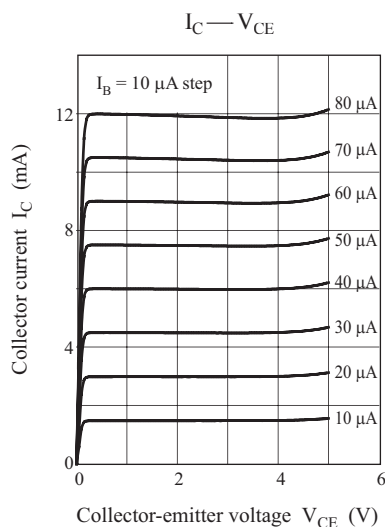
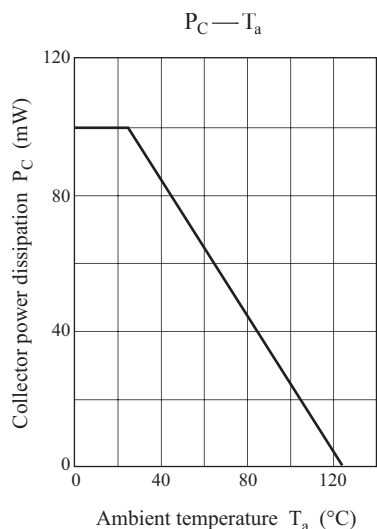
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

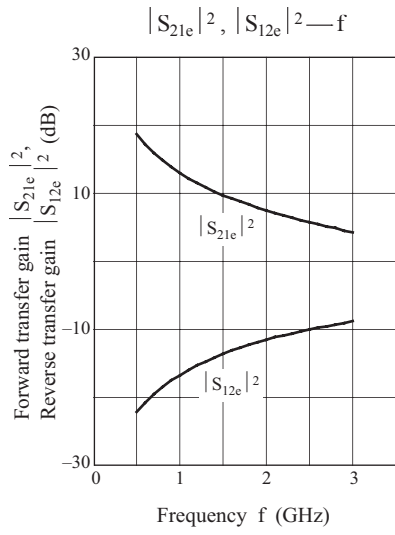
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 9\text{ V}, I_E = 0$			1	μA
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = 6\text{ V}, I_B = 0$			1	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 1\text{ V}, I_C = 0$			1	μA
Forward current transfer ratio	h_{FE}	$V_{CE} = 3\text{ V}, I_C = 15\text{ mA}$	100		220	—
Transition frequency *	f_T	$V_{CE} = 3\text{ V}, I_C = 30\text{ mA}, f = 2\text{ GHz}$		16		GHz
Forward transfer gain *	$ S_{21e} ^2$	$V_{CE} = 3\text{ V}, I_C = 30\text{ mA}, f = 2\text{ GHz}$	5.0	8.0		dB
Noise figure *	NF	$V_{CE} = 3\text{ V}, I_C = 15\text{ mA}, f = 2\text{ GHz}$		1.6	2.2	dB
Collector output capacitance (Common base, input open circuited) *	C_{ob}	$V_{CB} = 3\text{ V}, I_E = 0, f = 1\text{ MHz}$		0.8	1.1	pF

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
 2. Observe precautions for handling. Electrostatic sensitive devices.
 3. *: Verified by random sampling



Marking Symbol: 4Y





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